

PATENT ASSIGNMENT

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NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Vamsy CHODAVARAPU	11/24/2009
Mark TRIFIRO	11/24/2009
RECEIVING PARTY DATA	
Name:	The Royal Institution for the Advancement of Learning/McGill University
Street Address:	1555 Peel Street
Internal Address:	11th Floor
City:	Montreal, Quebec
State/Country:	CANADA
Postal Code:	H3A 3L8
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12950286
CORRESPONDENCE DATA	
Fax Number:	(613)238-8775
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	613-238-2022
Email:	ip@perlaw.ca
Correspondent Name:	PERLEY-ROBERTSON, HILL & MCDUGALL LLP
Address Line 1:	1400-340 Albert Street
Address Line 4:	OTTAWA, ON, CANADA K1R 0A5
ATTORNEY DOCKET NUMBER:	MGIL-024PUS
NAME OF SUBMITTER:	Trevor C. Klotz
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ASSIGNMENT

WE, Vamsy CHODAVARAPU; Mark TRIFIRO whose full post office addresses in Canada are respectively, 1865 Amelia Earhart St., St-Laurent, QC, H4R 2V1, Canada and 11350 Meunier, Montreal, QC, H3L 2Z6, Canada, in consideration of the sum of \$1.00 now paid and in furtherance of other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, do hereby sell and assign to The Royal Institution for the Advancement of Learning/McGill University, whose full post office address in Canada is 1555 Peel Street, 11th Floor, Montreal, Quebec, Canada H3A 3L8, Canada, all of our right, title and interest in the United States of America and its territories and possessions, Canada, and in all other countries of the world in and to our invention entitled SELF CALIBRATING HIGH THROUGHPUT INTEGRATED IMPEDANCE SPECTROMETER FOR BIOLOGICAL APPLICATIONS as more fully described and claimed in a U.S. Provisional patent application to be filed in our names as U.S. applicants for such invention, and in and to all of our corresponding right, title and interest in any subsequently filed patent applications based thereon or derived therefrom and including, without limitation, any and all U.S. non-provisional patent filings, international patent filings, regional patent filings and national patent filings as well as any and all patents to issue or reissue in any country or region of the world from such filings.

SIGNED at Montreal, Quebec, Canada, this 24th day of November, 2009.



Witness



Vamsy CHODAVARAPU



Witness



Mark TRIFIRO